10

## THAT WHICH IS CLAIMED IS:

1. A RESURF LDMOS integrated structure realized in a first region (DRAIN\_WELL) of a first type of conductivity defined in a semiconductor substrate (P-SUBSTRATE) of opposite type of conductivity and comprising a source region of said first type of conductivity formed in a body region of said opposite type of conductivity, characterized in that

said body region is contained within a superficial portion (BODY\_BUFFER\_REGION) of said first region (DRAIN\_WELL) more heavily doped than the rest of the region.

- 2. The integrated structure of claim 1, wherein said first region (DRAIN\_WELL) has a depth comprised between 1.5 and 4.5 micrometers and doping comprised between 2.5x10% and 2.5x10<sup>16</sup> atoms cm<sup>-3</sup>, said superficial portion (BODY BUFFER\_REGION) is comprised between 0.15 and 0.45 micrometers deep and has a doping comprised between 5x10<sup>16</sup> and 5x10<sup>17</sup> atoms cm<sup>-3</sup> and the depth of said body region is comprised between 0.25 and 0.75 micrometers and has a doping comprised between 10 5x10<sup>17</sup> and 5x10<sup>18</sup> atoms cm<sup>-3</sup>.
  - 3. The integrated structure according to claims 1 or 2, wherein said first region (DRAIN\_WELL) and said superficial portion thereof (BODY\_BUFFER\_REGION) are doped with phosphorous while said body region is doped with boron.

The integrated structure according to one of the claims 1 of 2, wherein said first region (DRAIN\_WELL) and said superficial portion thereof (BODY\_BUFFER\_REGION) are doped with boron while said body region is doped with phosphorus.

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